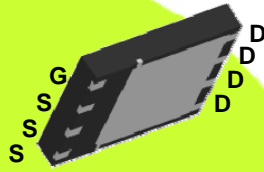


# N-Channel CICLON NexFET™ Power MOSFETs CSD16414Q5

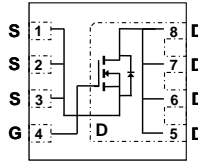


## Features

- Ultra Low Qg & Qgd
- Low Thermal Resistance
- Avalanche Rated
- Pb Free Terminal Plating
- RoHS Compliant
- Halogen Free



QFN 5mm x 6mm Plastic Package



Top View

## Product Summary

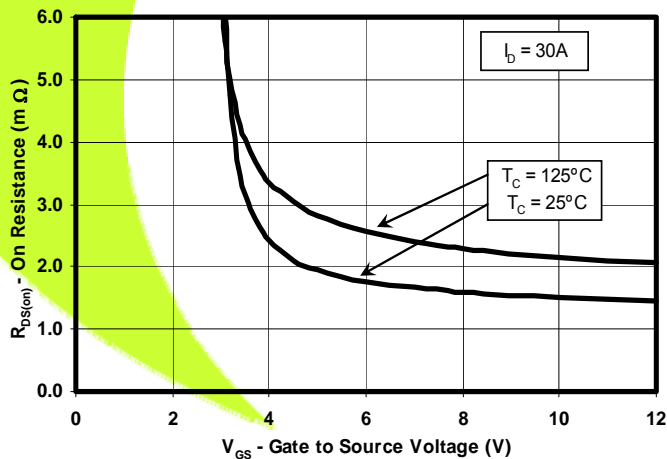
|              |               |                |
|--------------|---------------|----------------|
| $V_{DS}$     | 25            | V              |
| $Q_g$        | 16.6          | nC             |
| $Q_{gd}$     | 4.4           | nC             |
| $R_{DS(on)}$ | $V_{GS}=4.5V$ | 2.1 m $\Omega$ |
|              | $V_{GS}=10V$  | 1.5 m $\Omega$ |
| $V_{th}$     | 1.6           | V              |

## Maximum Values ( $T_A=25^\circ C$ unless otherwise stated)

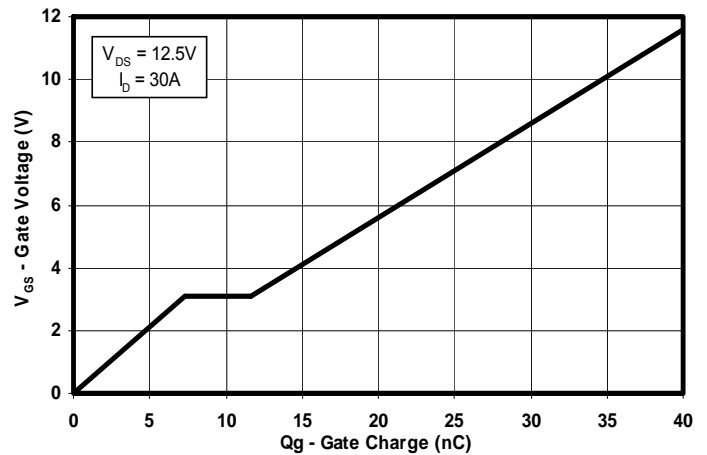
| Symbol         | Parameter  | Value      | Units      |
|----------------|--|------------|------------|
| $V_{DS}$       | Drain to Source Voltage  | 25         | V          |
| $V_{GS}$       | Gate to Source Voltage   | +16 / -12  | V          |
| $I_D$          | Continuous Drain Current, $T_C = 25^\circ C$                         | 100        | A          |
|                | Continuous Drain Current <sup>1</sup>                                | 34         | A          |
| $I_{DM}$       | Pulsed Drain Current, $T_A = 25^\circ C^2$                           | 213        | A          |
| $P_D$          | Power Dissipation <sup>1</sup>                                       | 3.2        | W          |
| $T_J, T_{STG}$ | Operating Junction and Storage Temperature Range                     | -55 to 150 | $^\circ C$ |
| $E_{AS}$       | Avalanche Energy, single pulse $I_D=100A, L = 0.1mH, R_G = 25\Omega$ | 500        | mJ         |

1.  $R_{\theta JA} = 39^\circ C/W$  on 1in<sup>2</sup> Cu (2 oz.) on 0.060" thick FR4 PCB.
2. See Figure 10

## $R_{DS(on)}$ vs. $V_{GS}$



## Gate Charge



## Ordering Information

| Type       | Package                 | Package Media | Qty  | Ship          |
|------------|-------------------------|---------------|------|---------------|
| CSD16414Q5 | QFN 5X6 Plastic Package | 13 inch reel  | 2500 | Tape and Reel |

N-Channel  
**CICLON NexFET™ Power MOSFETs**  
**CSD16414Q5**



**Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise stated)

| Symbol                         | Parameter                        | Test Conditions   | Min | Typ  | Max  | Units     |
|--------------------------------|----------------------------------|---|-----|------|------|-----------|
| <b>Static Characteristics</b>  |                                  |   |     |      |      |           |
| $BV_{DSS}$                     | Drain to Source Voltage          | $V_{GS} = 0V, I_D = 250\mu A$                                       | 25  | —    | —    | V         |
| $I_{DSS}$                      | Drain to Source Leakage Current  | $V_{GS} = 0V, V_{DS} = 20V$   | —   | —    | 1    | $\mu A$   |
| $I_{GSS}$                      | Gate to Source Leakage Current   | $V_{DS} = 0V, V_{GS} = +16/-12V$                                    | —   | —    | 100  | nA        |
| $V_{GS(th)}$                   | Gate to Source Threshold Voltage | $V_{DS} = V_{GS}, I_D = 250\mu A$                                   | 1.3 | 1.6  | 2.0  | V         |
| $R_{DS(on)}$                   | Drain to Source On Resistance    | $V_{GS} = 4.5V, I_D = 30A$  | —   | 2.1  | 2.6  | $m\Omega$ |
|                                |                                  | $V_{GS} = 10V, I_D = 30A$   | —   | 1.5  | 1.9  | $m\Omega$ |
| $g_{fs}$                       | Transconductance                 | $V_{DS} = 15V, I_D = 30A$   | —   | 138  | —    | S         |
| <b>Dynamic Characteristics</b> |                                  |   |     |      |      |           |
| $C_{ISS}$                      | Input Capacitance                | $V_{GS} = 0V, V_{DS} = 12.5V$<br>$f = 1MHz$                         | —   | 2810 | 3650 | pF        |
| $C_{OSS}$                      | Output Capacitance               |   | —   | 2040 | 2650 | pF        |
| $C_{RSS}$                      | Reverse Transfer Capacitance     |   | —   | 140  | 180  | pF        |
| $R_g$                          | Series Gate Resistance           |   | —   | 1.3  | —    | $\Omega$  |
| $Q_g$                          | Gate Charge Total (4.5V)         | $V_{DS} = 12.5V, I_D = 30A$   | —   | 16.6 | 21   | nC        |
| $Q_{gd}$                       | Gate Charge Gate to Drain        |   | —   | 4.4  | —    | nC        |
| $Q_{gs}$                       | Gate Charge Gate to Source       |   | —   | 7.3  | —    | nC        |
| $Q_{g(th)}$                    | Gate Charge at $V_{th}$          |   | —   | 4.5  | —    | nC        |
| $Q_{OSS}$                      | Output Charge                    | $V_{DS} = 13.5V, V_{GS} = 0V$                                       | —   | 40   | —    | nC        |
| $t_{d(on)}$                    | Turn On Delay Time               | $V_{DS} = 12.5V$<br>$V_{GS} = 4.5V, I_D = 30A$<br>$R_G = 3.0\Omega$ | —   | 21   | —    | ns        |
| $t_r$                          | Rise Time                        |   | —   | 35   | —    | ns        |
| $t_{d(off)}$                   | Turn Off Delay Time              |   | —   | 25   | —    | ns        |
| $t_f$                          | Fall Time                        |   | —   | 20   | —    | ns        |
| <b>Diode Characteristics</b>   |                                  |   |     |      |      |           |
| $V_{SD}$                       | Diode Forward Voltage            | $I_S = 30A, V_{GS} = 0V$  | —   | 0.81 | 1.0  | V         |
| $Q_{rr}$                       | Reverse Recovery Charge          | $V_{dd} = 13.5V, I_F = 30A,$<br>$di/dt = 300A/\mu s$                | —   | 44   | —    | nC        |
| $t_{rr}$                       | Reverse Recovery Time            | $V_{dd} = 13.5V, I_F = 30A,$<br>$di/dt = 300A/\mu s$                | —   | 35   | —    | ns        |

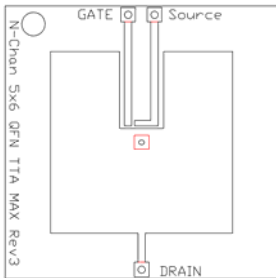
# N-Channel CICLON NexFET™ Power MOSFETs CSD16414Q5



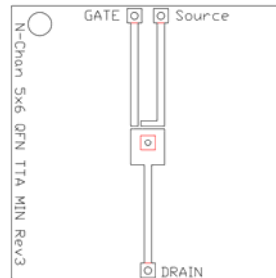
## Thermal Characteristics (T<sub>A</sub> = 25°C unless otherwise stated)

| Symbol                         | Parameter   | Min | Typ | Max | Units |
|--------------------------------|---|-----|-----|-----|-------|
| <b>Thermal Characteristics</b> |   |     |     |     |       |
| R <sub>θJC</sub>               | Thermal Resistance Junction to Case <sup>3</sup>      | —   | —   | 1.1 | °C/W  |
| R <sub>θJA</sub>               | Thermal Resistance Junction to Ambient <sup>3,4</sup> | —   | —   | 50  | °C/W  |

- R<sub>θJC</sub> is determined with the device mounted on a 1in square 2 oz. Cu pad on a 1.5x1.5 in .060in thick FR4 board. R<sub>θJC</sub> is guaranteed by design while R<sub>θca</sub> is determined by the user's board design.
- Device mounted on FR4 Material with 1in<sup>2</sup> of 2 oz. Cu.



Max R<sub>θJA</sub> = 50°C/W when mounted on 1in<sup>2</sup> of 2 oz. Cu.



Max R<sub>θJA</sub> = 122°C/W when mounted on min pad area of 2 oz. Cu.

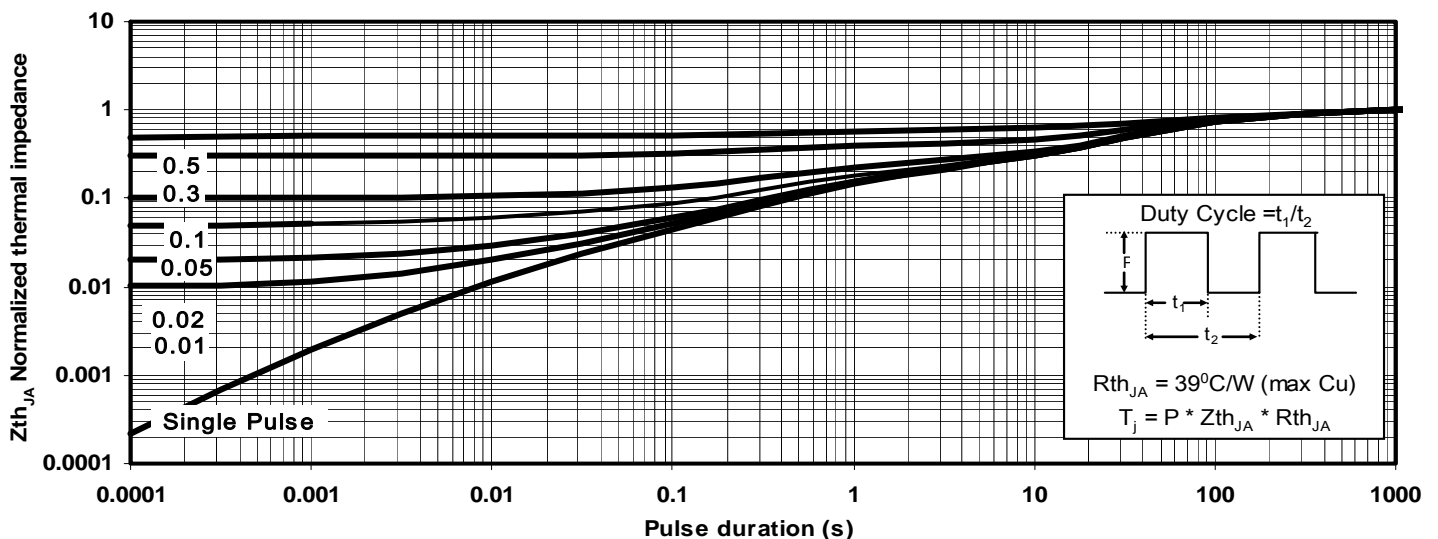


Figure 1: Transient Thermal Impedance

# N-Channel CICLON NexFET™ Power MOSFETs CSD16414Q5



Typical MOSFET Characteristics ( $T_A = 25^\circ\text{C}$  unless otherwise stated)

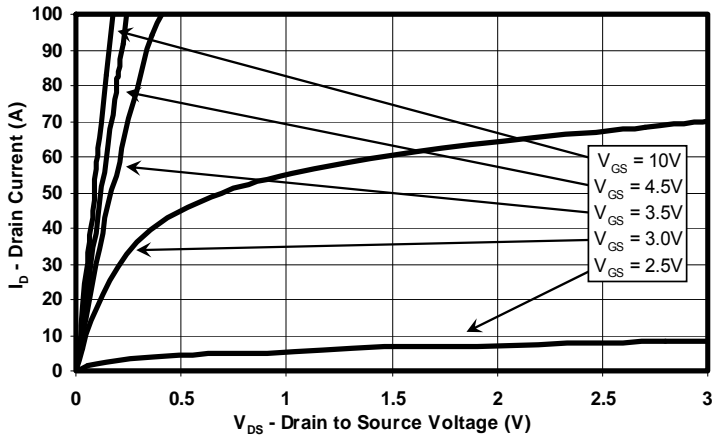


Figure 2: Saturation Characteristics

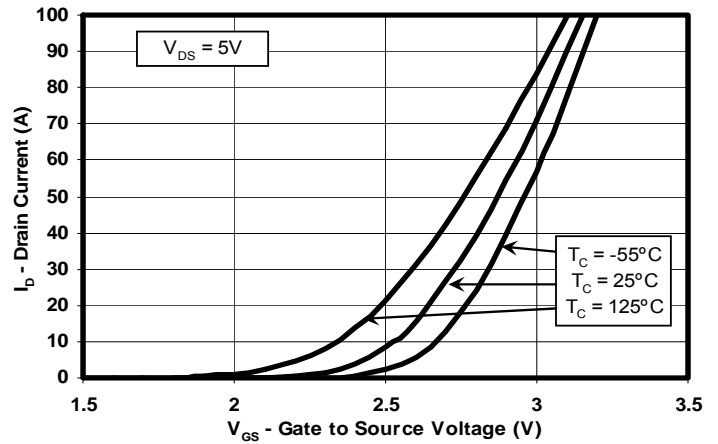


Figure 3: Transfer Characteristics

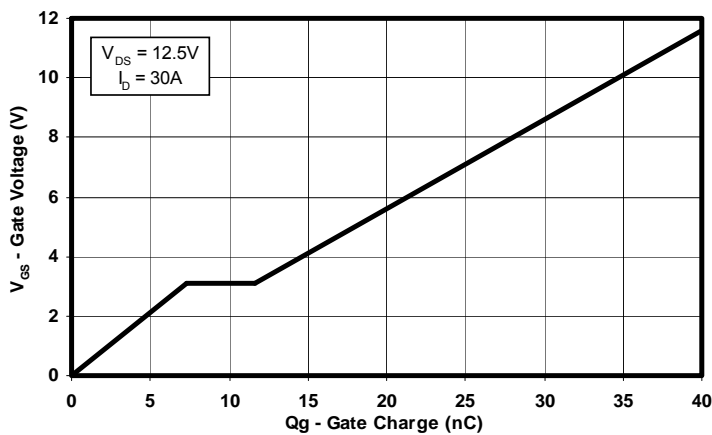


Figure 4: Gate Charge

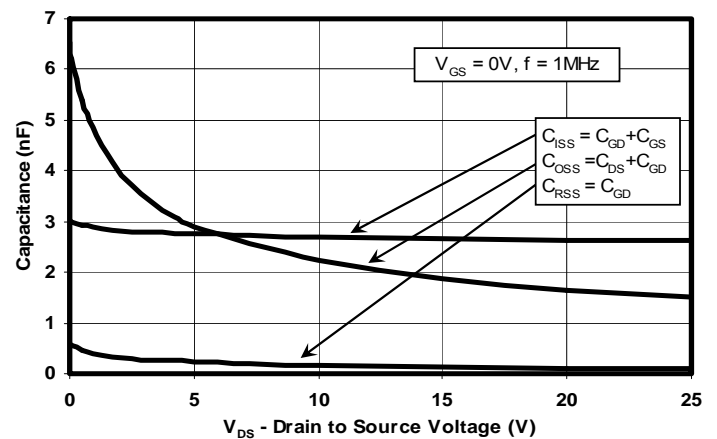


Figure 5: Capacitance

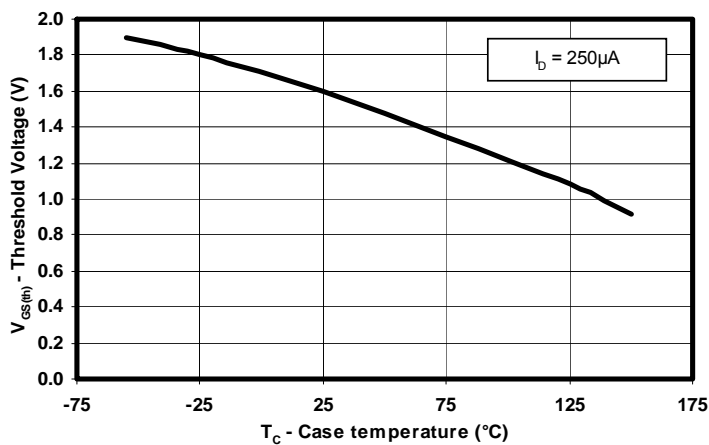


Figure 6: Threshold Voltage vs. Temperature

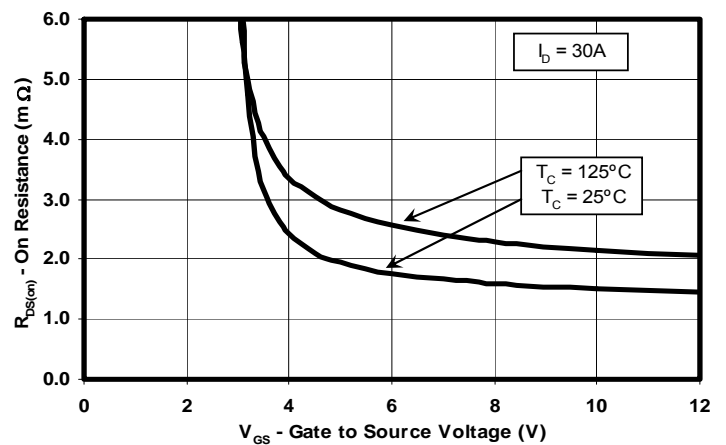


Figure 7: On Resistance vs. Gate Voltage

# N-Channel CICLON NexFET™ Power MOSFETs CSD16414Q5



## Typical MOSFET Characteristics ( $T_A = 25^\circ\text{C}$ unless otherwise stated)

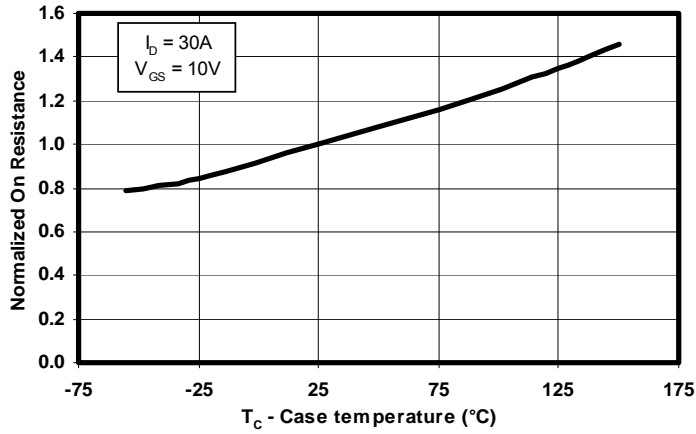


Figure 8: On Resistance vs. Temperature

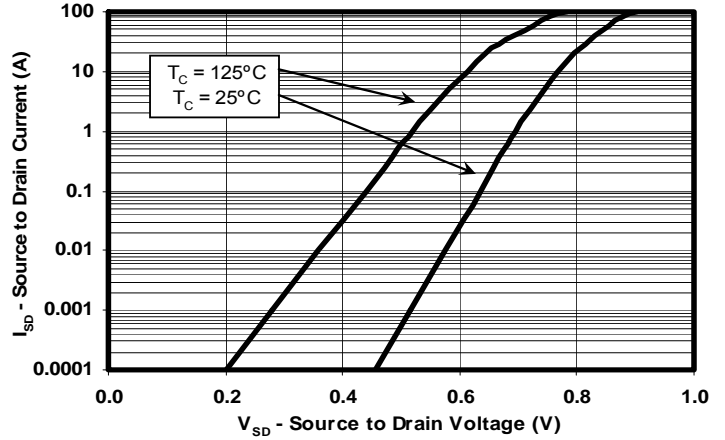


Figure 9: Typical Diode Forward Voltage

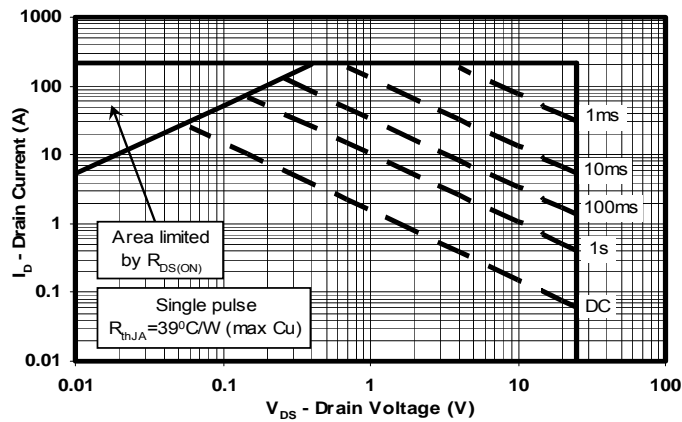


Figure 10: Maximum Safe Operating Area

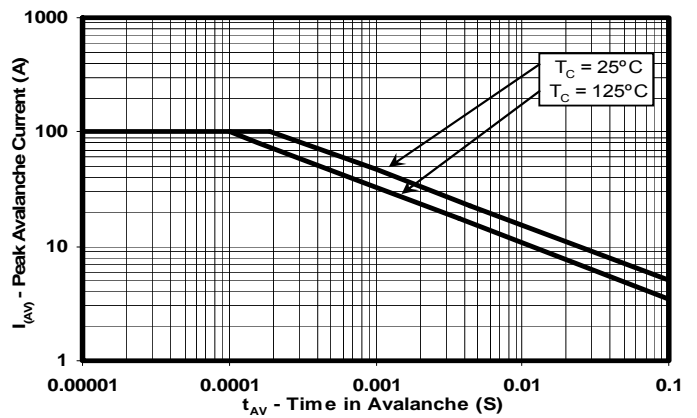


Figure 11: Single Pulse Unclamped Inductive Switching

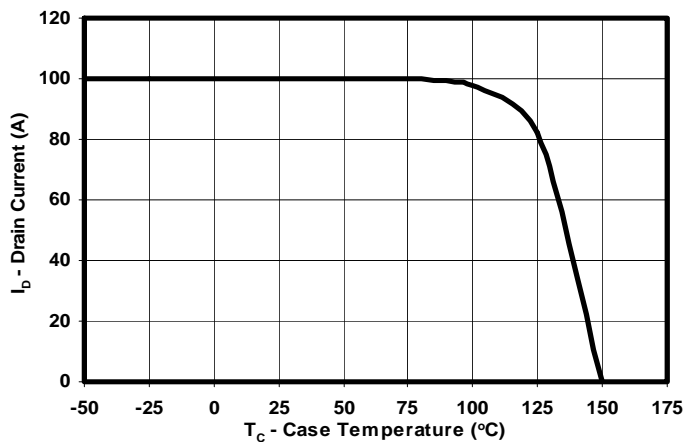
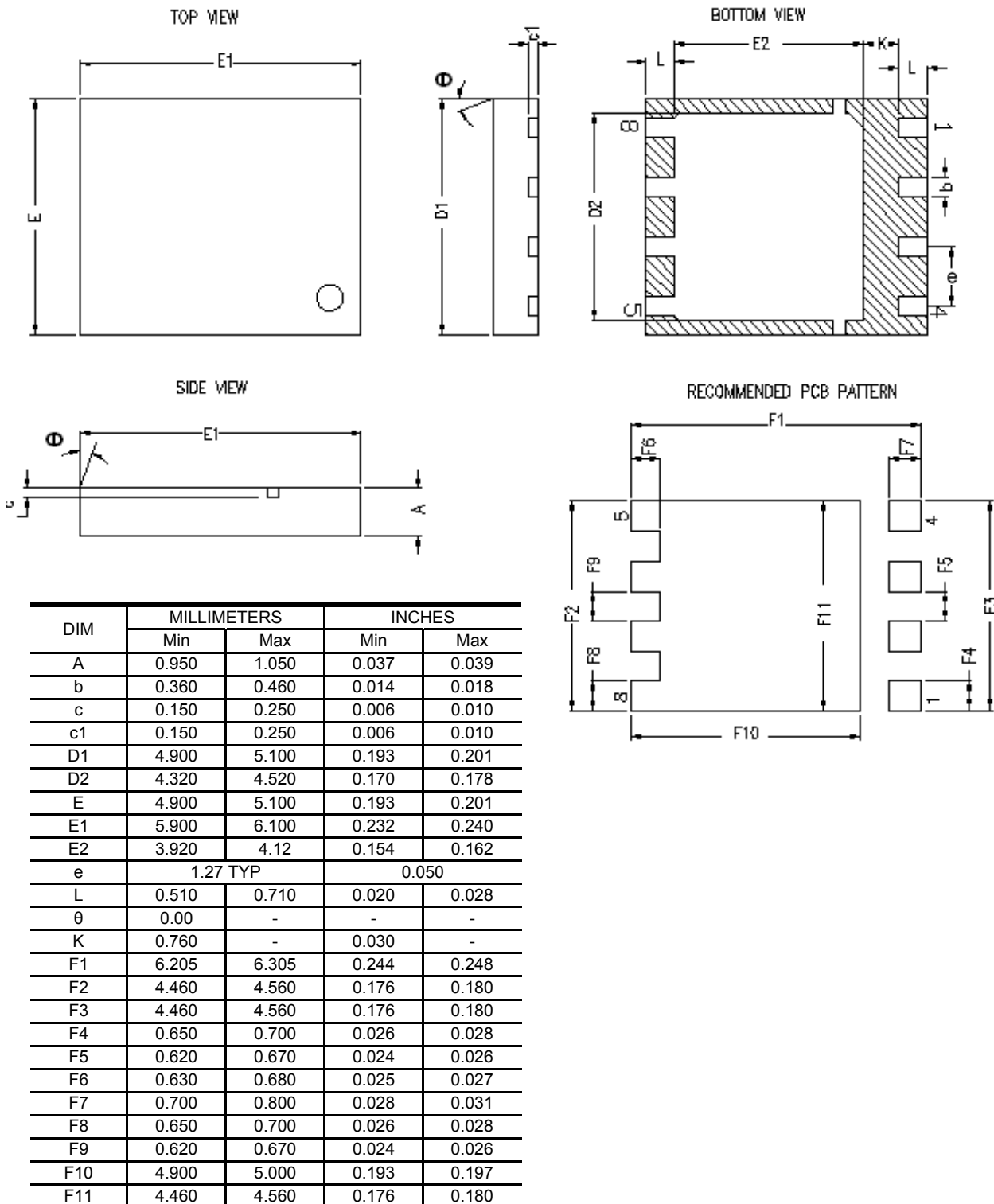


Figure 12: Maximum Drain Current vs. Temperature

# N-Channel CICLON NexFET™ Power MOSFETs CSD16414Q5



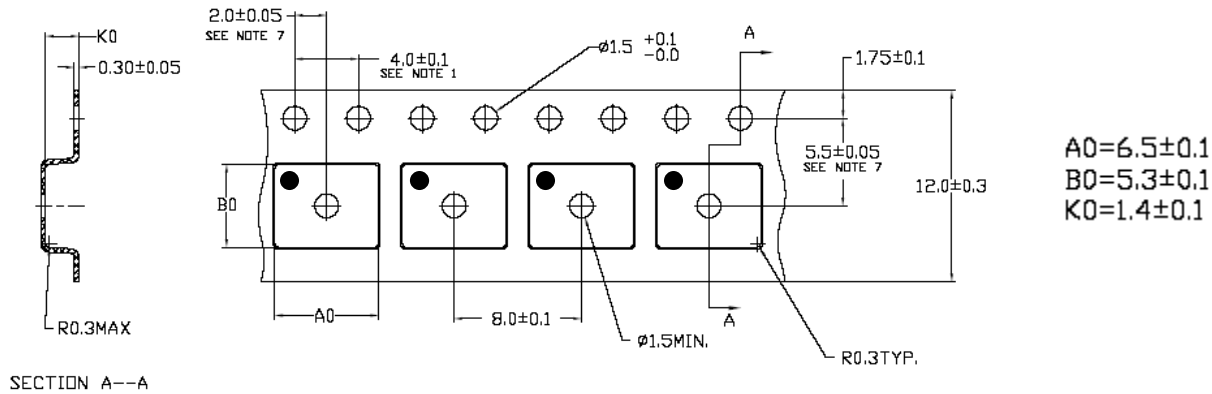
## CSD16414Q5 Package Dimensions



N-Channel  
**CICLON NexFET™ Power MOSFETs**  
**CSD16414Q5**



**Q5 Tape and Reel Information**



**Note:**

1. 10 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE +/-0.2
2. CAMBER NOT TO EXCEED 1mm IN 100mm, NONCUMULATIVE OVER 250mm
3. MATERIAL:BLACK STATIC DISSIPATIVE POLYSTYRENE
4. ALL DIMENSIONS ARE IN mm (UNLESS OTHERWISE SPECIFIED)
5. THICKNESS: 0.30 +/-0.05mm

**Package Marking Information**

Location:

1st Line

CSD = Fixed Characters

NNNNN = Product Code

2nd Line (Date Code)

YY = Last 2 digits of the Year

WW = 2-digit Work Week

C = Country of Origin

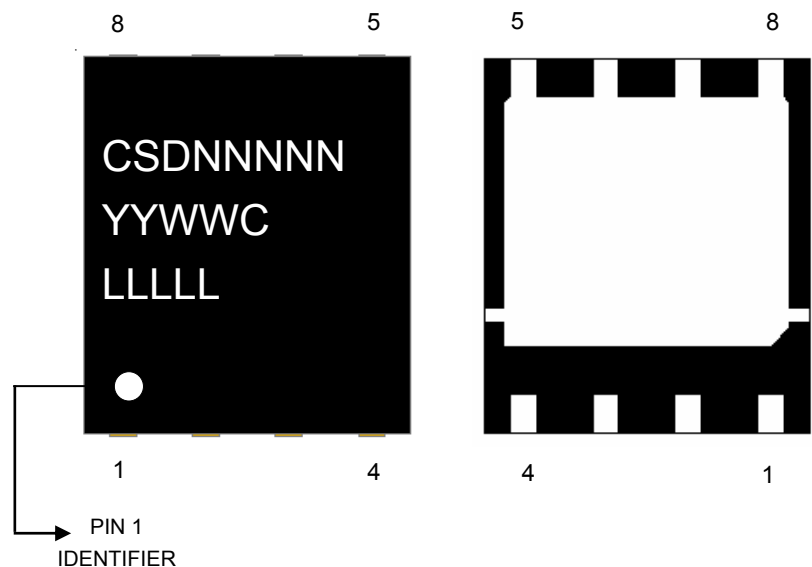
> Philippines = P

> Taiwan = T

> China = C

3rd Line

LLLLL= Last 5 digits of the Wafer Lot #



N-Channel  
**CICLON** NexFET™ Power MOSFETs  
CSD16414Q5



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